## FGD3040G2-F085C FGB3040G2-F085C

## **EcoSPARK<sup>®</sup> 2 Ignition IGBT** 300 mJ, 400 V, N–Channel Ignition IGBT

#### Features

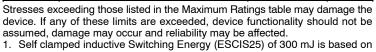
- SCIS Energy = 300 mJ at  $T_J = 25^{\circ}C$
- Logic Level Gate Drive
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

#### Applications

- Automotive Ignition Coil Driver Circuits
- High Current Ignition System
- Coil on Plug Application

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
BV <sub>CER</sub>	Collector to Emitter Breakdown Voltage (IC = 1 mA)	400	V
BV <sub>ECS</sub>	Emitter to Collector Voltage – Reverse Battery Condition (IC = 10 mA)	28	V
E <sub>SCIS25</sub>	ISCIS = 14.2 A, L = 3.0 mHy, RGE = 1 KΩ, T <sub>C</sub> = 25°C (Note 1)	300	mJ
E <sub>SCIS150</sub>	ISCIS = 10.8 A, L = 3.0 mHy, RGE = 1 KΩ, T <sub>C</sub> = 150°C (Note 2)	170	mJ
IC25	Collector Current Continuous at VGE = 5.0 V, $T_C = 25^{\circ}C$	41	A
IC110	Collector Current Continuous at VGE = 5.0 V, T <sub>C</sub> = 110°C	25.6	A
$V_{\text{GEM}}$	Gate to Emitter Voltage Continuous	±10	V
PD	Power Dissipation Total, $T_C = 25^{\circ}C$	150	W
	Power Dissipation Derating, $T_C > 25^{\circ}C$	1	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating Junction and Storage Temperature	–55 to +175	°C
ΤL	Lead Temperature for Soldering Purposes (1/8" from case for 10 s)	300	°C
T <sub>PKG</sub>	Reflow Soldering according to JESD020C	260	°C
ESD	HBM-Electrostatic Discharge Voltage at 100 pF, 1500 $\Omega$	4	kV
	CDM–Electrostatic Discharge Voltage at 1 $\Omega$	2	kV

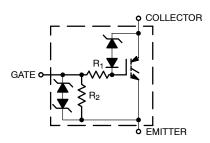


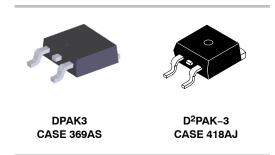
- 1. Self clamped inductive Switching Energy (ESCIS25) of 300 mJ is based on the test conditions that is starting  $T_J = 25^{\circ}C$ , L = 3 mHy, ISCIS = 14.2 A, VCC = 100 V during inductor charging and VCC = 0 V during time in clamp.
- 2. Self Clamped inductive Switching Energy (ESCIS150) of 170 mJ is based on the test conditions that is starting  $T_J = 150^{\circ}$ C, L = 3mHy, ISCIS = 10.8 A, VCC = 100 V during inductor charging and VCC = 0 V during time in clamp.



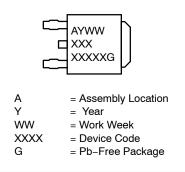
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#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

#### THERMAL RESISTANCE RATINGS

Characteristic		Мах	Units
Junction-to-Case - Steady State (Drain)		1	°C/W

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

Symbol	Parameter	Test Conditions		Min	Тур.	Max.	Units
FF CHARA	ACTERISTICS						
BV <sub>CER</sub>	Collector to Emitter Breakdown Voltage	$\begin{split} I_{CE} &= 2 \text{ mA, } V_{GE} \ = 0 \text{ V,} \\ R_{GE} &= 1  k\Omega, \\ T_J &= -40 \text{ to } 150^\circ\text{C} \end{split}$		370	400	430	V
BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage	$I_{CE} = 10 \text{ mA}, V_{GE} = 0 \text{ V}, R_{GE} = 0, T_{J} = -40 \text{ to } 150^{\circ}\text{C}$		390	420	450	V
BV <sub>ECS</sub>	Emitter to Collector Breakdown Voltage	$I_{CE}$ = -75 mA, $V_{GE}$ = 0 V, T <sub>J</sub> = 25°C		28	_	_	V
<b>BV<sub>GES</sub></b>	Gate to Emitter Breakdown Voltage	$I_{GES} = \pm 2 \text{ mA}$		±12	±14	-	V
ICER	Collector to Emitter Leakage Current	V <sub>CE</sub> = 175 V	$T_J = 25^{\circ}C$	-	-	25	μA
		$R_{GE} = 1 \ k\Omega$	$T_J = 150^{\circ}C$	-	-	1	mA
I <sub>ECS</sub>	Emitter to Collector Leakage Current	V <sub>EC</sub> = 24 V	$T_J = 25^{\circ}C$	-	-	1	mA
			$T_J = 150^{\circ}C$	-	-	40	1
R <sub>1</sub>	Series Gate Resistance			-	120	-	Ω
R <sub>2</sub>	Gate to Emitter Resistance	1		10K	-	30K	Ω
N CHARA	CTERISTICS						
V <sub>CE(SAT)</sub>	Collector to Emitter Saturation Voltage	$I_{CE} = 6 \text{ A}, V_{GE} = 4 \text{ V}, T_{J} = 25^{\circ}\text{C}$		-	1.15	1.25	V
V <sub>CE(SAT)</sub>	Collector to Emitter Saturation Voltage	$I_{CE}$ = 10 A, $V_{GE}$ = 4.5 V, $T_{J}$ = 150°C		-	1.35	1.50	V
V <sub>CE(SAT)</sub>	Collector to Emitter Saturation Voltage	$I_{CE}$ = 15 A, $V_{GE}$ = 5 V, $T_{J}$ = 150°C		-	1.68	1.85	V
YNAMIC C	HARACTERISTICS	•		•	-		
Q <sub>G(ON)</sub>	Gate Charge	I <sub>CE</sub> = 10 A, V <sub>CE</sub>	= 12 V, V <sub>GE</sub> = 5 V	-	21	-	nC
V <sub>GE(TH)</sub>	Gate to Emitter Threshold Voltage	$ \begin{array}{c} I_{CE} = 1 \text{ mA} \\ V_{CE} = V_{GE} \end{array} \qquad \begin{array}{c} T_J = 25^\circ C \\ T_J = 150^\circ C \end{array} $	$T_J = 25^{\circ}C$	1.3	1.5	2.2	V
			$T_J = 150^{\circ}C$	0.75	1.2	1.8	]
V <sub>GEP</sub>	Gate to Emitter Plateau Voltage	V <sub>CE</sub> = 12 V, I <sub>CE</sub> = 10 A		-	2.8	-	V
WITCHING	CHARACTERISTICS						
td <sub>(ON)R</sub>	Current Turn-On Delay Time-Resistive			_	0.9	4	μs
t <sub>rR</sub>	Current Rise Time-Resistive			-	1.9	7	1
td <sub>(OFF)L</sub>	Current Turn–Off Delay Time–Inductive			_	4.8	10	]
	Current Fall Time-Inductive				2.0	15	-1

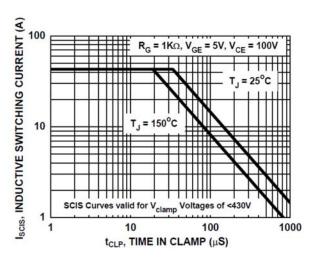
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

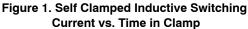
#### PACKAGE MARKING AND ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
FGD3040G2-F085C	DPAK (Pb-Free)	2500 Units / Tape & Reel
FGB3040G2-F085C	D <sup>2</sup> PAK (Pb-Free)	800 Units / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### TYPICAL CHARACTERISTICS





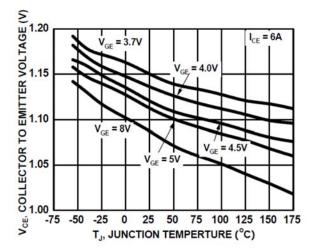


Figure 3. Collector to Emitter On–State Voltage vs. Junction Temperature

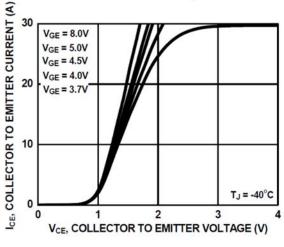


Figure 5. Collector to Emitter On–State Voltage vs. Collector Current

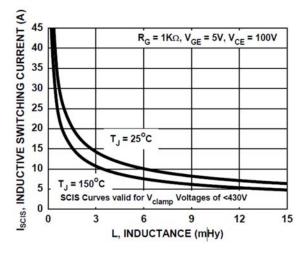


Figure 2. Self Clamped Inductive Switching Current vs. Inductance

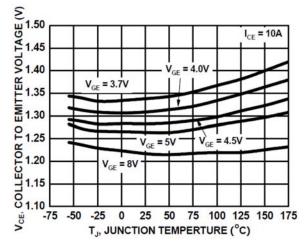


Figure 4. Collector to Emitter On–State Voltage vs. Junction Temperature

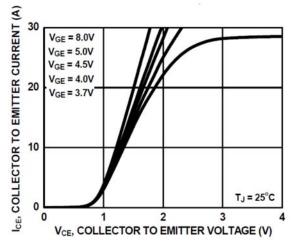


Figure 6. Collector to Emitter On–State Voltage vs. Collector Current

#### TYPICAL CHARACTERISTICS (continued)

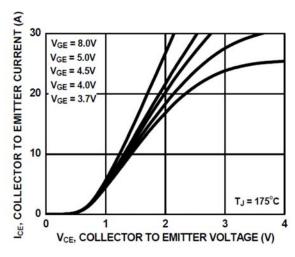
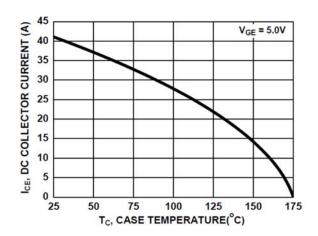
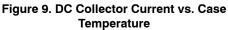


Figure 7. Collector to Emitter On–State Voltage vs. Collector Current





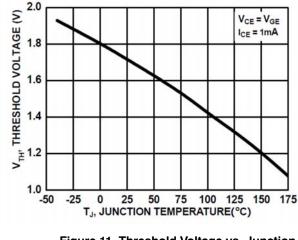
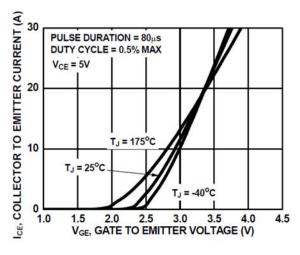


Figure 11. Threshold Voltage vs. Junction Temperature





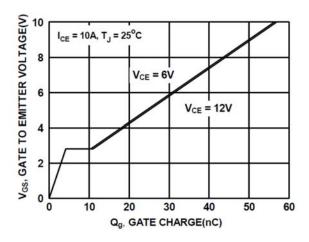
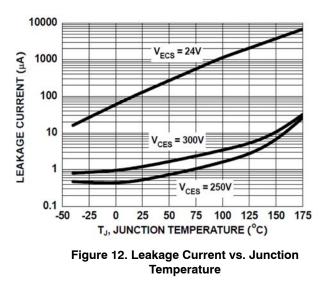


Figure 10. Gate Charge



#### TYPICAL CHARACTERISTICS (continued)

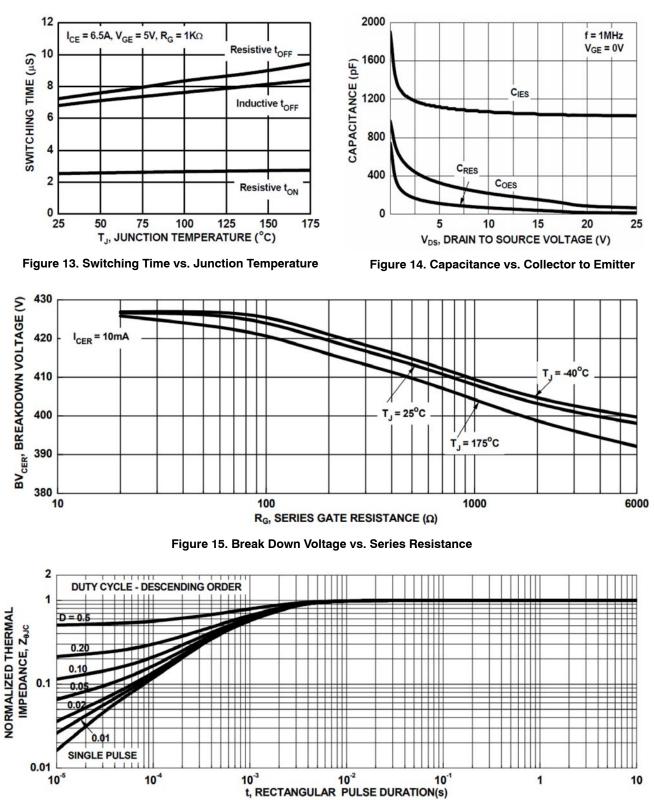


Figure 16. IGBT Normalized Transient Thermal Impedance, Junction to Case

#### **TEST CIRCUIT AND WAVEFORMS**

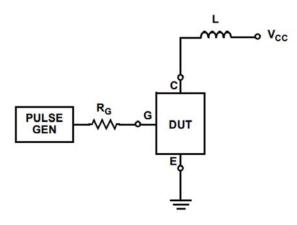


Figure 17. Inductive Switching Test Circuit

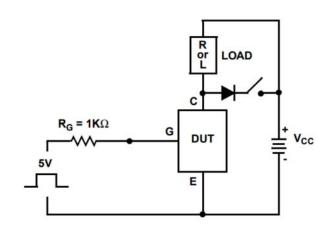


Figure 18.  $t_{\text{ON}}$  and  $t_{\text{OFF}}$  Switching Test Circuit

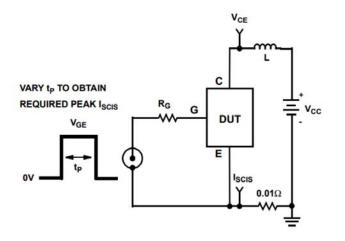


Figure 19. Energy Test Circuit

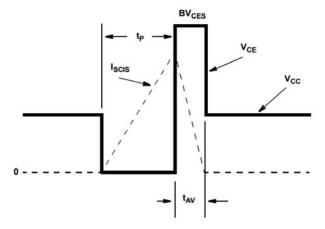
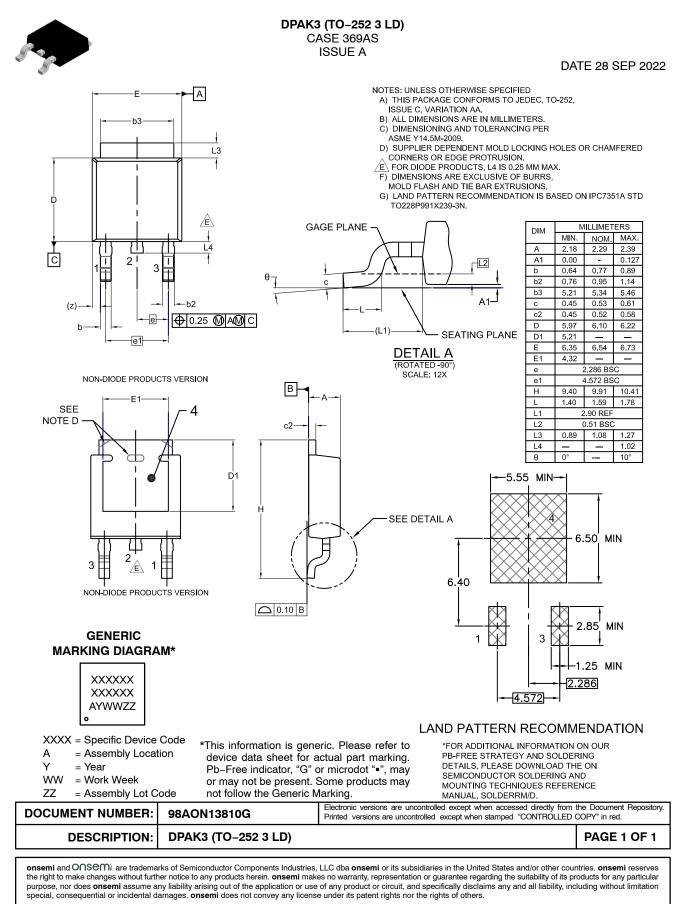


Figure 20. Energy Waveforms

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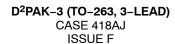
#### MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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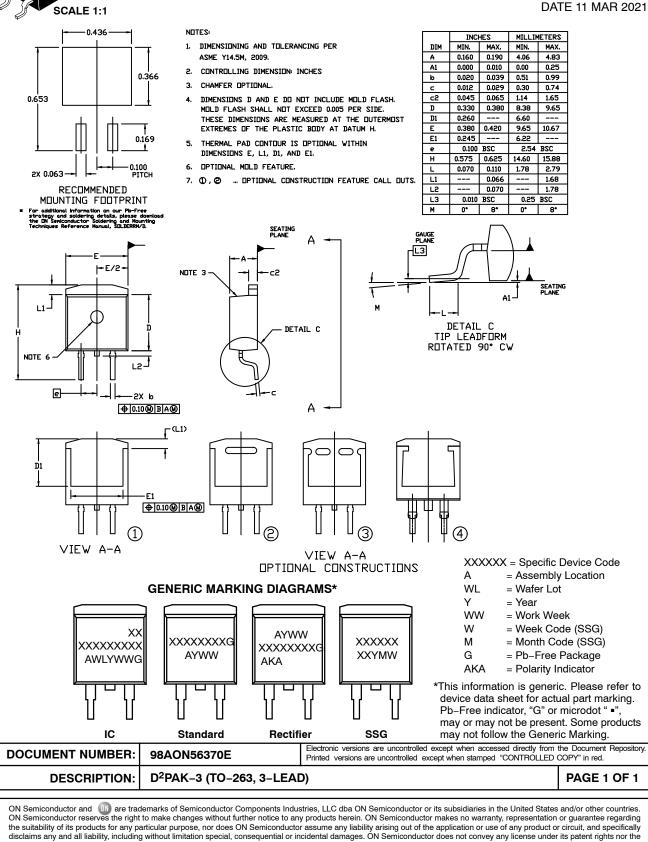


#### **MECHANICAL CASE OUTLINE** PACKAGE DIMENSIONS









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